

# ”Fast” Relaxation in Low Energy Muons Experiments

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## Abstract

The analysis is based on the year-2003 data (Cu, Stainless steel and Ni), where all 4 histograms were collected. Fits were done by WKM program using a ”separate histograms” grouping. This approach enables to follow the muon spin precession/evolution in details and to distinguish between ”physical” and ”systematic” fast relaxation. Some practical methods to measure ”physical” fast relaxation are summarized.

## 1 Conclusions based on Cu experiments

There is no fast relaxation in the bulk Cu. That is why the fast relaxing signal in Cu is supposed to be ”systematic”.

Due to the pronounced relaxation in zero field (at  $T=20$ ) it is possible to do fits with the single histograms grouping both for TF and ZF fields.

Experiments were done both with ”guards on” and ”guards off” regimes which makes it possible to compare different deacceleration regimes.

There is no fast relaxation down to 4keV in any regime (see Figures 1,2 for example).

At lower energies and ”guards on”, there is a ”distortion” in *all histograms* looking like *an increase* of counts at early times. Note that for ”a physical” process (muon is inside the sample or at/close to the sample’s surface) the increase of the counts in the histogram number 1(2) should be accompanied with similar decrease of the counts in the histogram number 3(4).

In the ”guards off” regime these distortions go down and **there is no fast relaxation/distortion for this regime in the histogram number 3**. See graphs 3,4,5,6 for the reference.

Conclusions:

- Always use ”guards of” regime for energies less than 4 keV.
- Always use the histogram type of fits instead of the asymmetry grouping to check is the ”fast” relaxation physical or not.

Some useful fits for the "physical" signal are shown in Fig 7, 8.

## 2 Conclusions based on Stainless Steel experiments

There is a mixture of physical and systematic fast relaxation in Stainless Steel.

In the bulk (at  $T=20\text{K}$ ), there is a very fast physical relaxation. Analysis shows that histogram number 2 is bad - there is no physical fast relaxation in this histogram. *One have to exclude early times of this histogram from the fit (see graphs 9,10 for details)*. This finding is confirmed by Ni data (see Fig. 11)

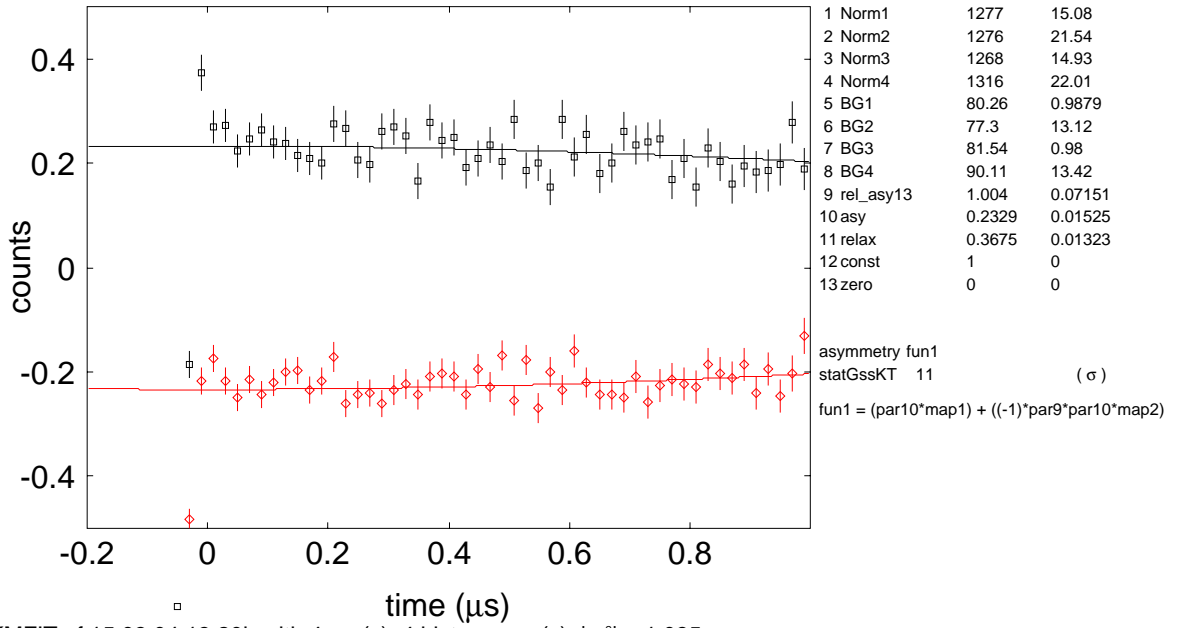
In Stainless Steel, near the surface the slow relaxing signal amplitude increases. This is compliment to the Cu signal (see Fig 12)

Slow relaxing signal in Stainless Steel is temperature dependent (see graph 13).

Conclusions:

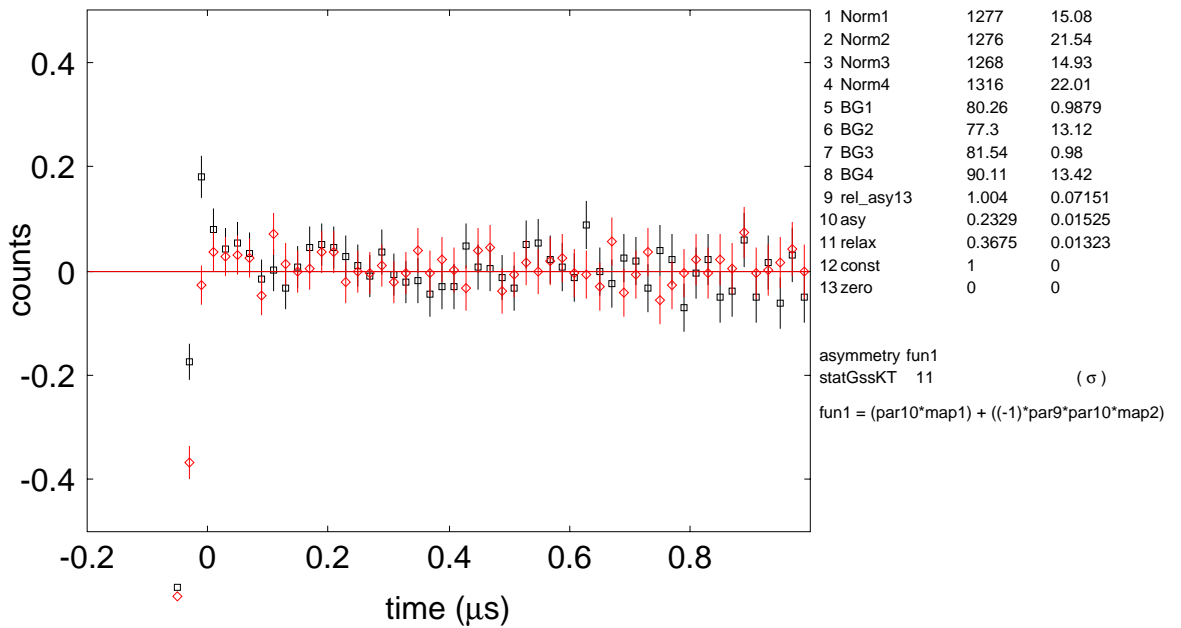
- In the year-2003 data fits skip first 20 ns in the histogram #2.
- Due to the very fast depolarization at low temperatures, the stainless still foil can be used as a substrate for the small samples at  $T < 40\text{ K}$  and down to 1.3k eV muon energy (until the "physical" relaxation in the sample is less than 50 MHz).

lem03\_0309\_nocut: Cu 500nm 4keV(10kV transport), 0G, 20K, G



WKMFIT of 15.03.04 13:20h with 4 run(s), 4 histogram(s),  $|\chi^2| = 1.035$   
 □ Run 1 (lem03\_0309\_nocut: Cu 500nm 4keV(10kV transport), 0G, 20K, Guards on T = 20.0 K B = -0.0000 muSR) Fitype 0, h:1, map 12 13, 0.20 bis 10.00, Pack 20  
 ◇ Run 2 (lem03\_0309\_nocut: Cu 500nm 4keV(10kV transport), 0G, 20K, Guards on T = 20.0 K B = -0.0000 muSR) Fitype 0, h:3, map 13 12, 0.20 bis 10.00, Pack 20

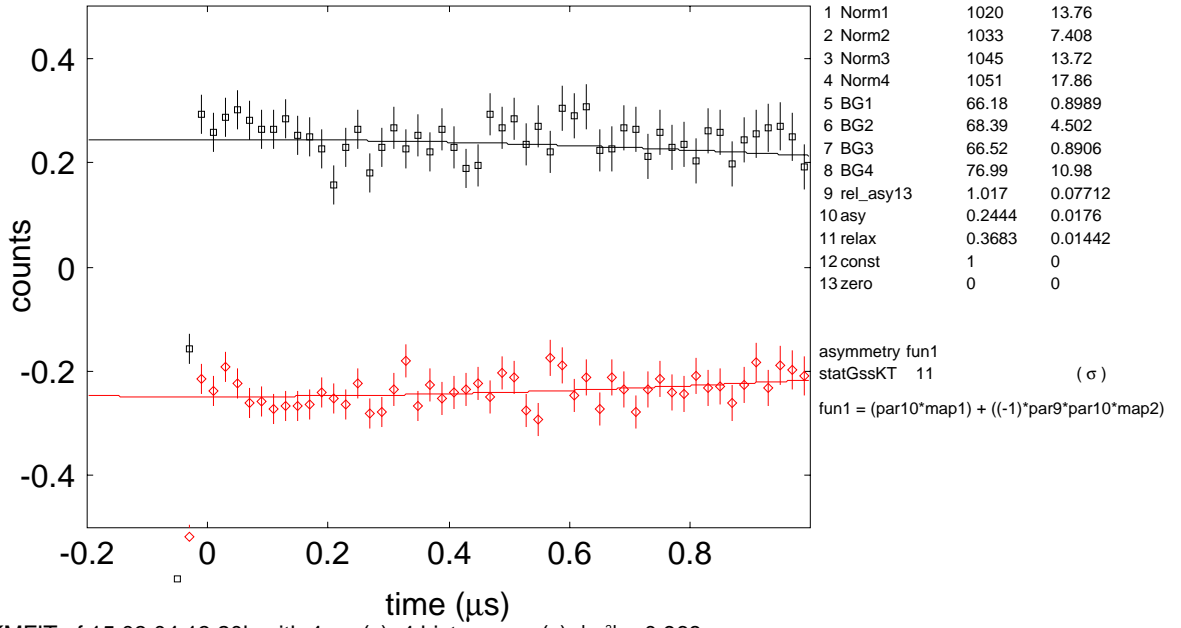
lem03\_0309\_nocut: Cu 500nm 4keV(10kV transport), 0G, 20K, G



WKMFIT of 15.03.04 13:20h with 4 run(s), 4 histogram(s),  $|\chi^2| = 1.035$   
 □ Run 1 (lem03\_0309\_nocut: Cu 500nm 4keV(10kV transport), 0G, 20K, Guards on T = 20.0 K B = -0.0000 muSR) Fitype 0, h:2, map 13 13, 0.20 bis 2.00, Pack 20  
 ◇ Run 2 (lem03\_0309\_nocut: Cu 500nm 4keV(10kV transport), 0G, 20K, Guards on T = 20.0 K B = -0.0000 muSR) Fitype 0, h:4, map 13 13, 0.20 bis 2.00, Pack 20

Figure 1: Cu ZF 20K E=4keV 10kV transport, guards on.

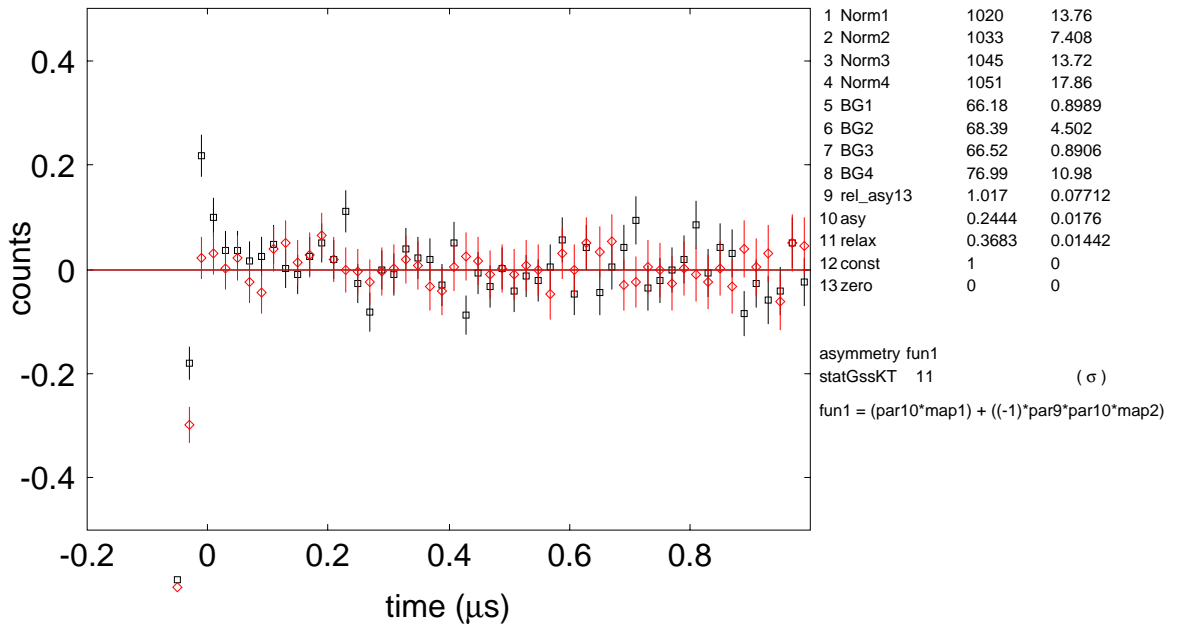
lem03\_0310\_nocut: Cu 500nm 4keV(10kV transport), 0G, 20K, G



WKMFIT of 15.03.04 13:20h with 4 run(s), 4 histogramm(s),  $|\chi^2| = 0.968$   
 □ Run 1 (lem03\_0310\_nocut : Cu 500nm 4keV(10kV transport), 0G, 20K, Guards off T = 20.0 K B = -0.0000 muSR) Fitype 0, h:1, map 12 13, 0.20 bis 10.00, Pack 20  
 ◇ Run 2 (lem03\_0310\_nocut : Cu 500nm 4keV(10kV transport), 0G, 20K, Guards off T = 20.0 K B = -0.0000 muSR) Fitype 0, h:3, map 13 12, 0.20 bis 10.00, Pack 20



lem03\_0310\_nocut: Cu 500nm 4keV(10kV transport), 0G, 20K, G

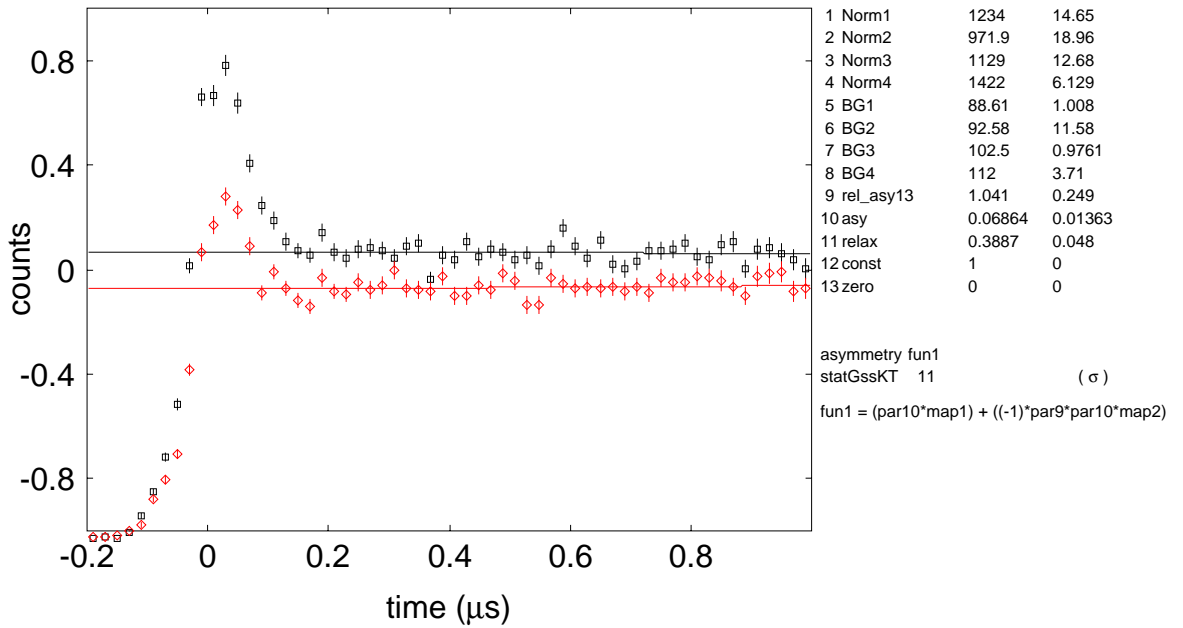


WKMFIT of 15.03.04 13:20h with 4 run(s), 4 histogramm(s),  $|\chi^2| = 0.968$   
 □ Run 1 (lem03\_0310\_nocut : Cu 500nm 4keV(10kV transport), 0G, 20K, Guards off T = 20.0 K B = -0.0000 muSR) Fitype 0, h:2, map 13 13, 0.20 bis 2.00, Pack 20  
 ◇ Run 2 (lem03\_0310\_nocut : Cu 500nm 4keV(10kV transport), 0G, 20K, Guards off T = 20.0 K B = -0.0000 muSR) Fitype 0, h:4, map 13 13, 0.20 bis 2.00, Pack 20



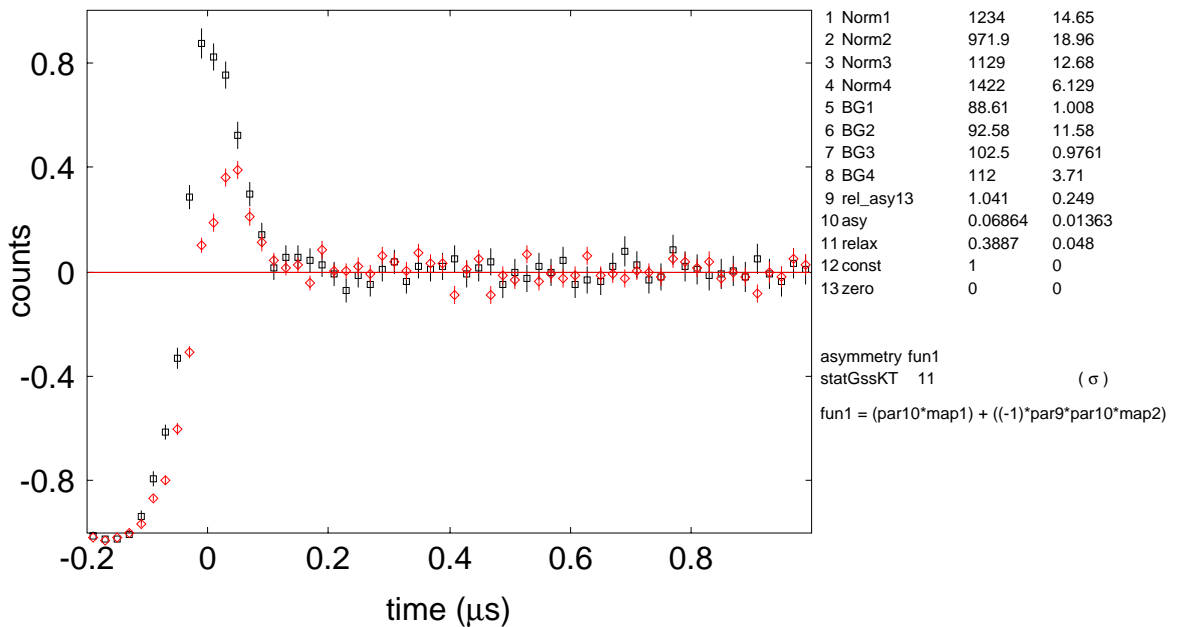
Figure 2: Cu ZF 20K E=4keV 10kV transport, guards off.

lem03\_0316\_nocut: Cu 500nm 0keV(10kV transport), ZF, 20K, G



WKMFIT of 15.03.04 13:22h with 4 run(s), 4 histogramm(s),  $|\chi^2| = 1.004$   
 □ Run 1 (lem03\_0316\_nocut : Cu 500nm 0keV(10kV transport), ZF, 20K, Guards on T = 20.0 K B = -0.0000 muSR) Fitype 0, h:1, map 12 13, 0.20 bis 10.00, Pack 20  
 ◇ Run 2 (lem03\_0316\_nocut : Cu 500nm 0keV(10kV transport), ZF, 20K, Guards on T = 20.0 K B = -0.0000 muSR) Fitype 0, h:3, map 13 12, 0.20 bis 10.00, Pack 20

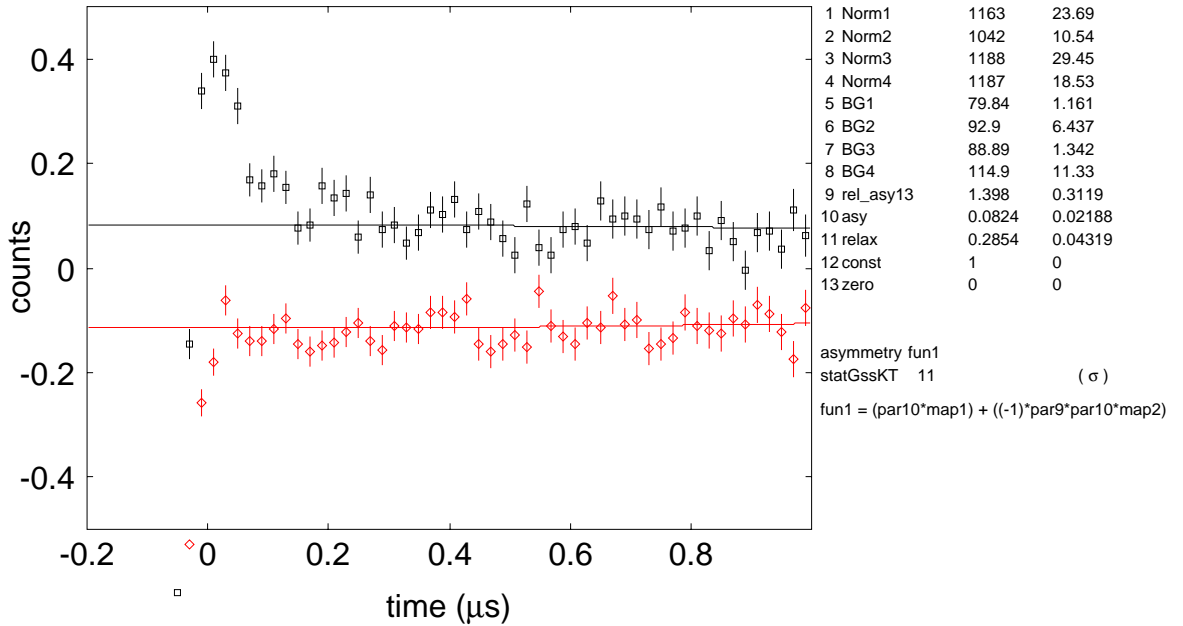
lem03\_0316\_nocut: Cu 500nm 0keV(10kV transport), ZF, 20K, G



WKMFIT of 15.03.04 13:22h with 4 run(s), 4 histogramm(s),  $|\chi^2| = 1.004$   
 □ Run 1 (lem03\_0316\_nocut : Cu 500nm 0keV(10kV transport), ZF, 20K, Guards on T = 20.0 K B = -0.0000 muSR) Fitype 0, h:2, map 13 13, 0.20 bis 2.00, Pack 20  
 ◇ Run 2 (lem03\_0316\_nocut : Cu 500nm 0keV(10kV transport), ZF, 20K, Guards on T = 20.0 K B = -0.0000 muSR) Fitype 0, h:4, map 13 13, 0.20 bis 2.00, Pack 20

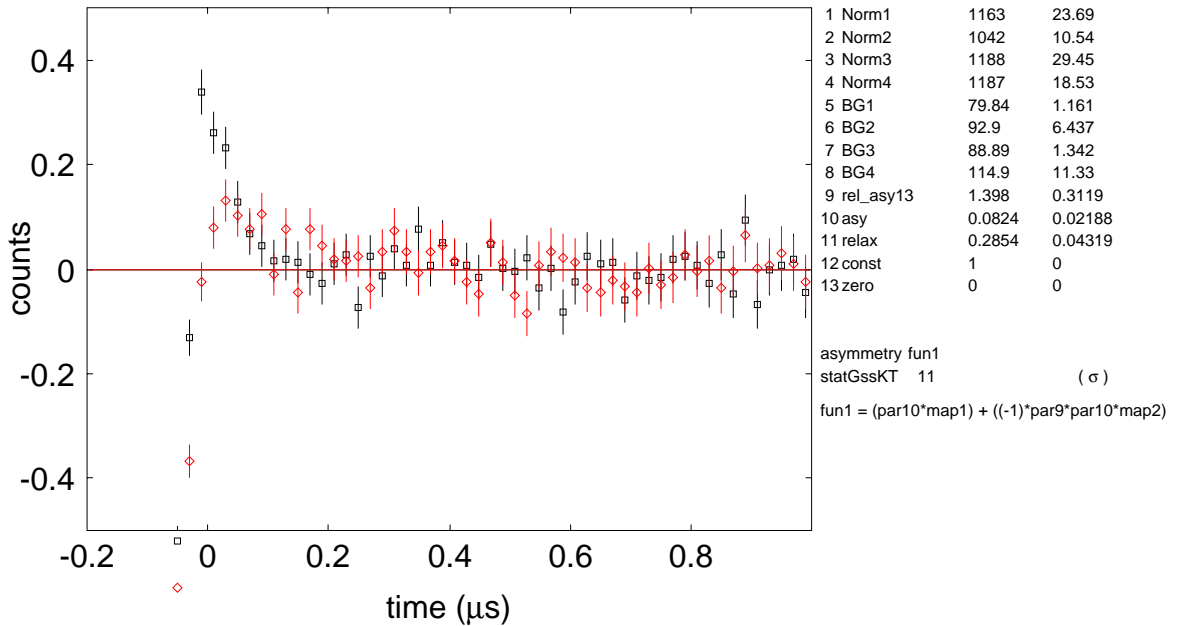
Figure 3: Cu ZF 20K E=0keV 10kV transport, guards on.

lem03\_0317\_nocut: Cu 500nm 0keV(10kV transport), ZF, 20K, G



WKMFIT of 15.03.04 13:22h with 4 run(s), 4 histogramm(s),  $|\chi^2| = 1.014$   
 □ Run 1 (lem03\_0317\_nocut : Cu 500nm 0keV(10kV transport), ZF, 20K, Guards off T = 20.0 K B = -0.0000 muSR) Fittype 0, h:1, map 12 13, 0.20 bis 10.00, Pack 20  
 ◇ Run 2 (lem03\_0317\_nocut : Cu 500nm 0keV(10kV transport), ZF, 20K, Guards off T = 20.0 K B = -0.0000 muSR) Fittype 0, h:3, map 13 12, 0.20 bis 10.00, Pack 20

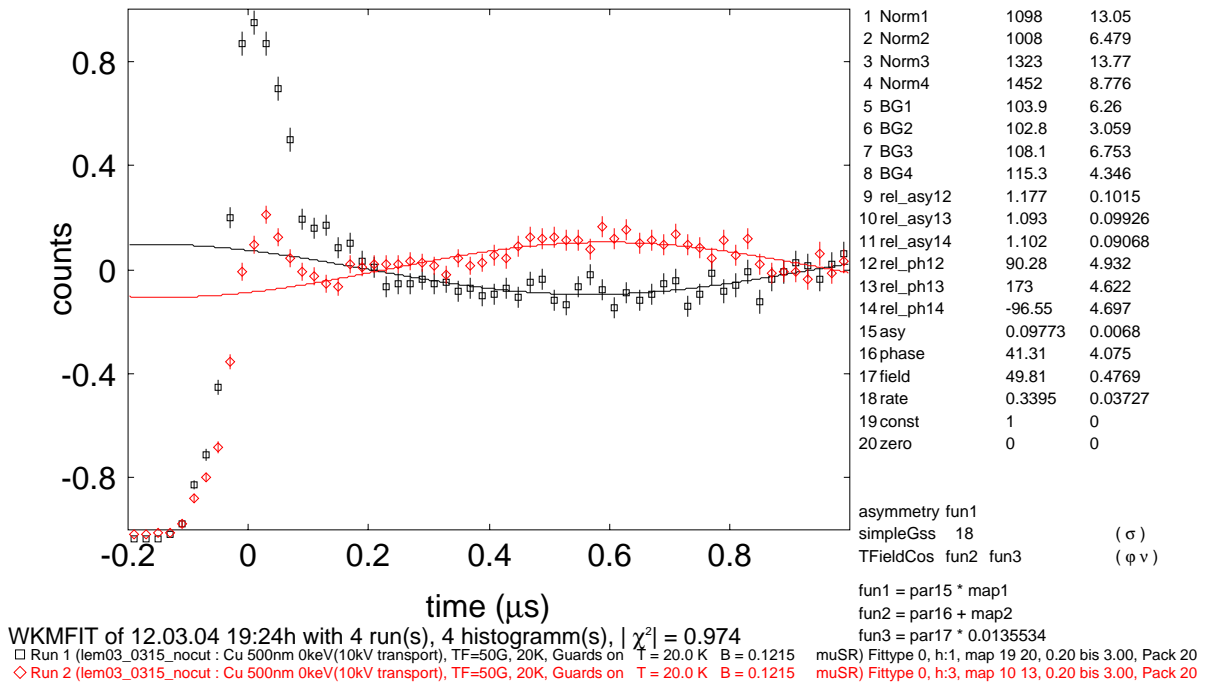
lem03\_0317\_nocut: Cu 500nm 0keV(10kV transport), ZF, 20K, G



WKMFIT of 15.03.04 13:22h with 4 run(s), 4 histogramm(s),  $|\chi^2| = 1.014$   
 □ Run 1 (lem03\_0317\_nocut : Cu 500nm 0keV(10kV transport), ZF, 20K, Guards off T = 20.0 K B = -0.0000 muSR) Fittype 0, h:2, map 13 13, 0.20 bis 2.00, Pack 20  
 ◇ Run 2 (lem03\_0317\_nocut : Cu 500nm 0keV(10kV transport), ZF, 20K, Guards off T = 20.0 K B = -0.0000 muSR) Fittype 0, h:4, map 13 13, 0.20 bis 2.00, Pack 20

Figure 4: Cu ZF 20K E=0keV 10kV transport, guards off.

lem03\_0315\_nocut: Cu 500nm 0keV(10kV transport), TF=50G, 20



lem03\_0315\_nocut: Cu 500nm 0keV(10kV transport), TF=50G, 20

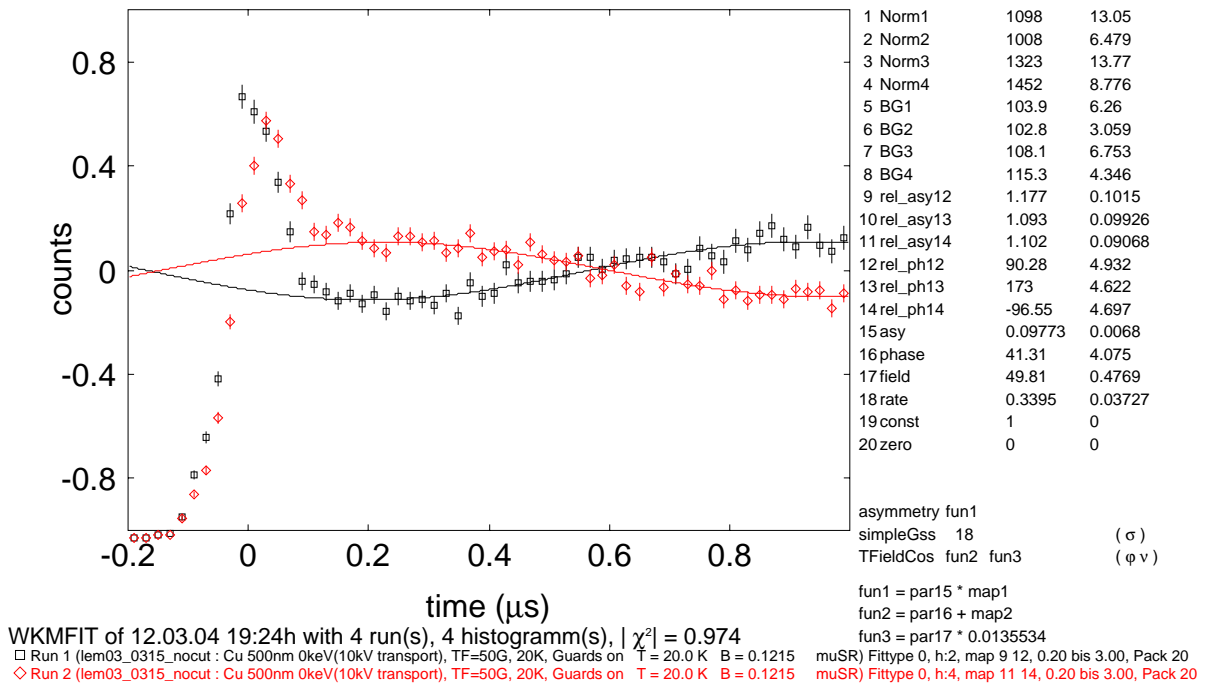
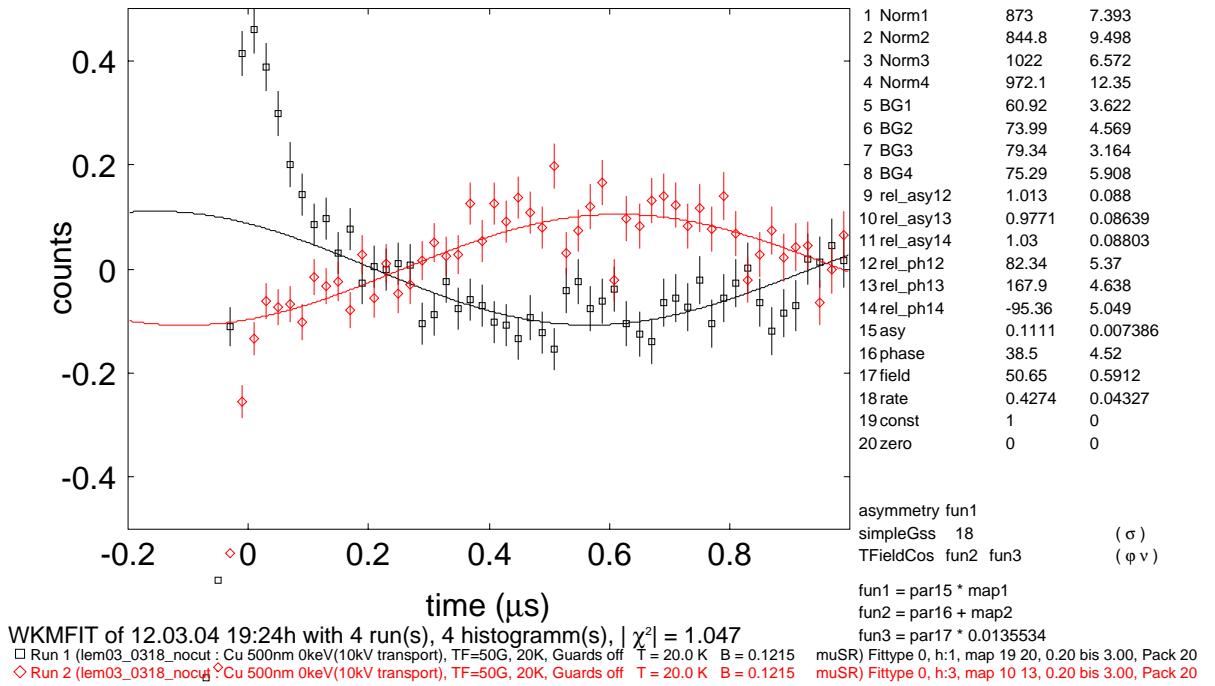


Figure 5: Cu TF=50G 20K E=0keV 10kV transport, guards on.

lem03\_0318\_nocut: Cu 500nm 0keV(10kV transport), TF=50G, 20



lem03\_0318\_nocut: Cu 500nm 0keV(10kV transport), TF=50G, 20

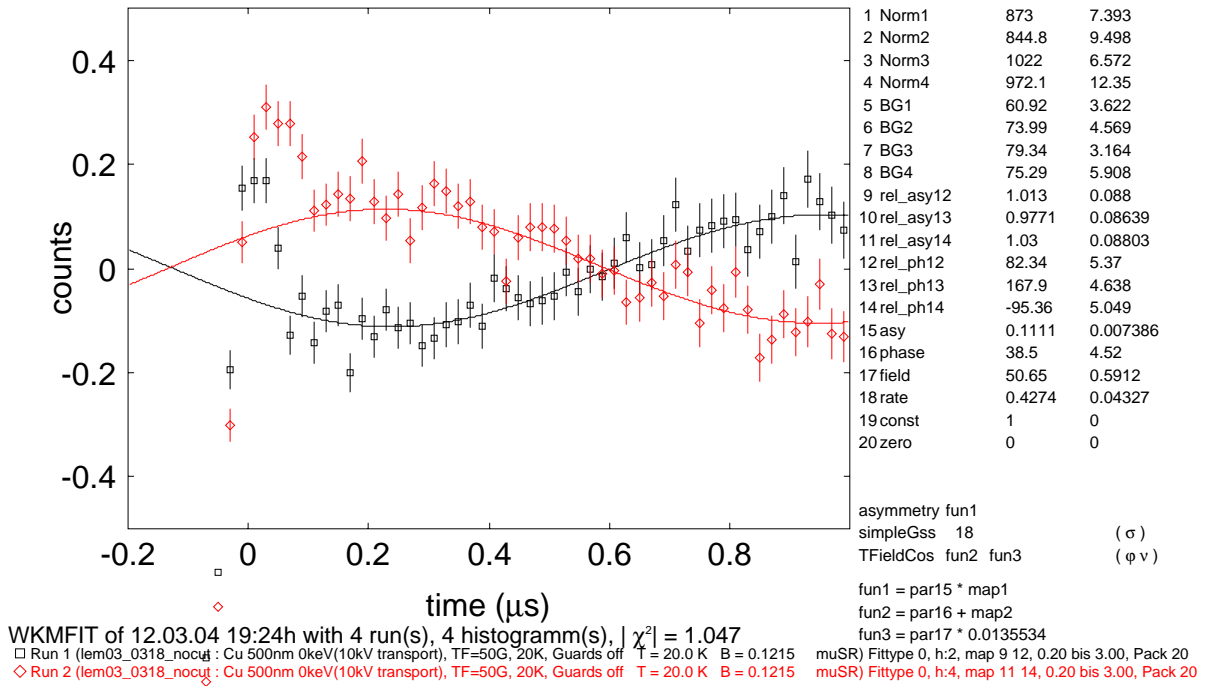


Figure 6: Cu TF=50G 20K E=0keV 10kV transport, guards off.



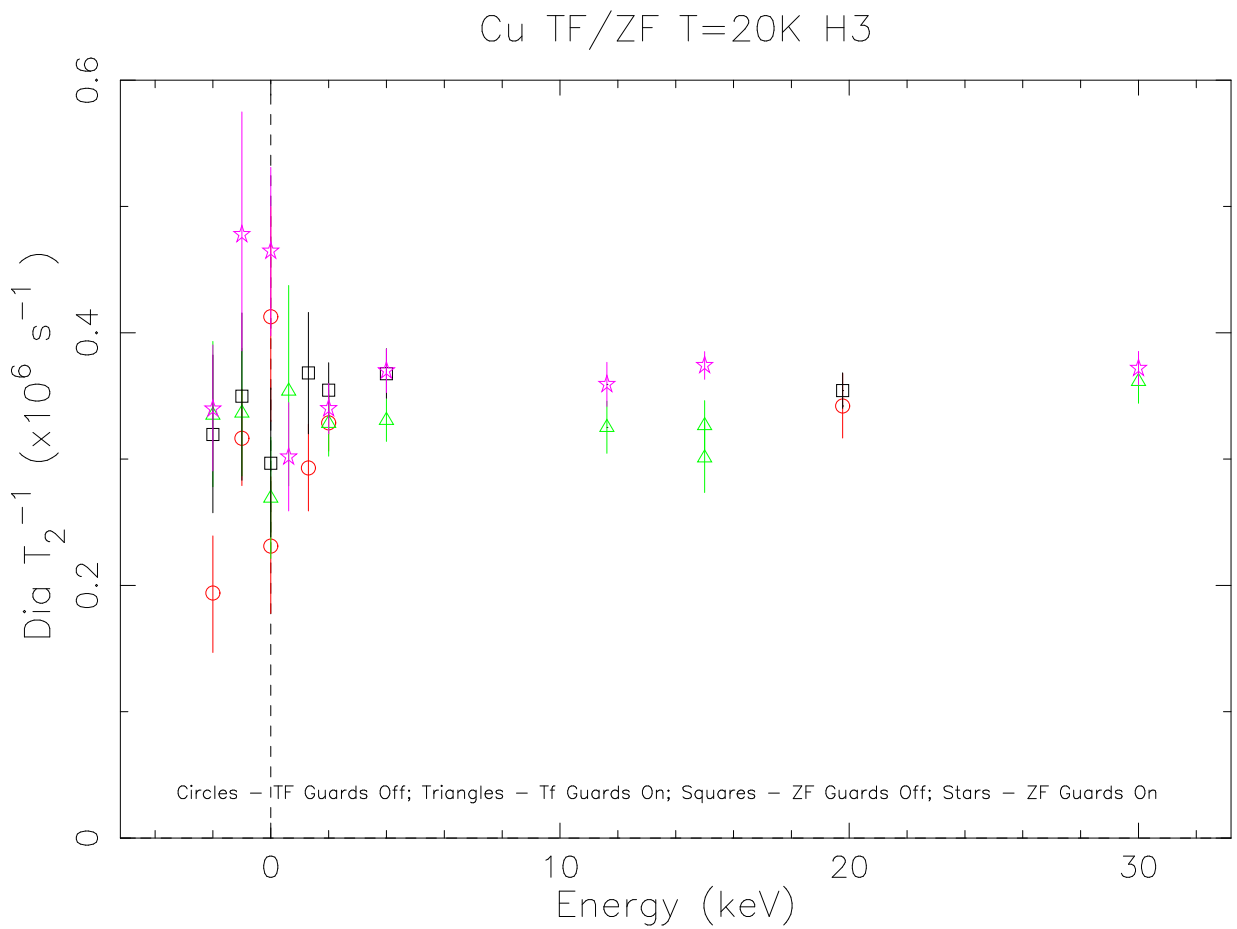
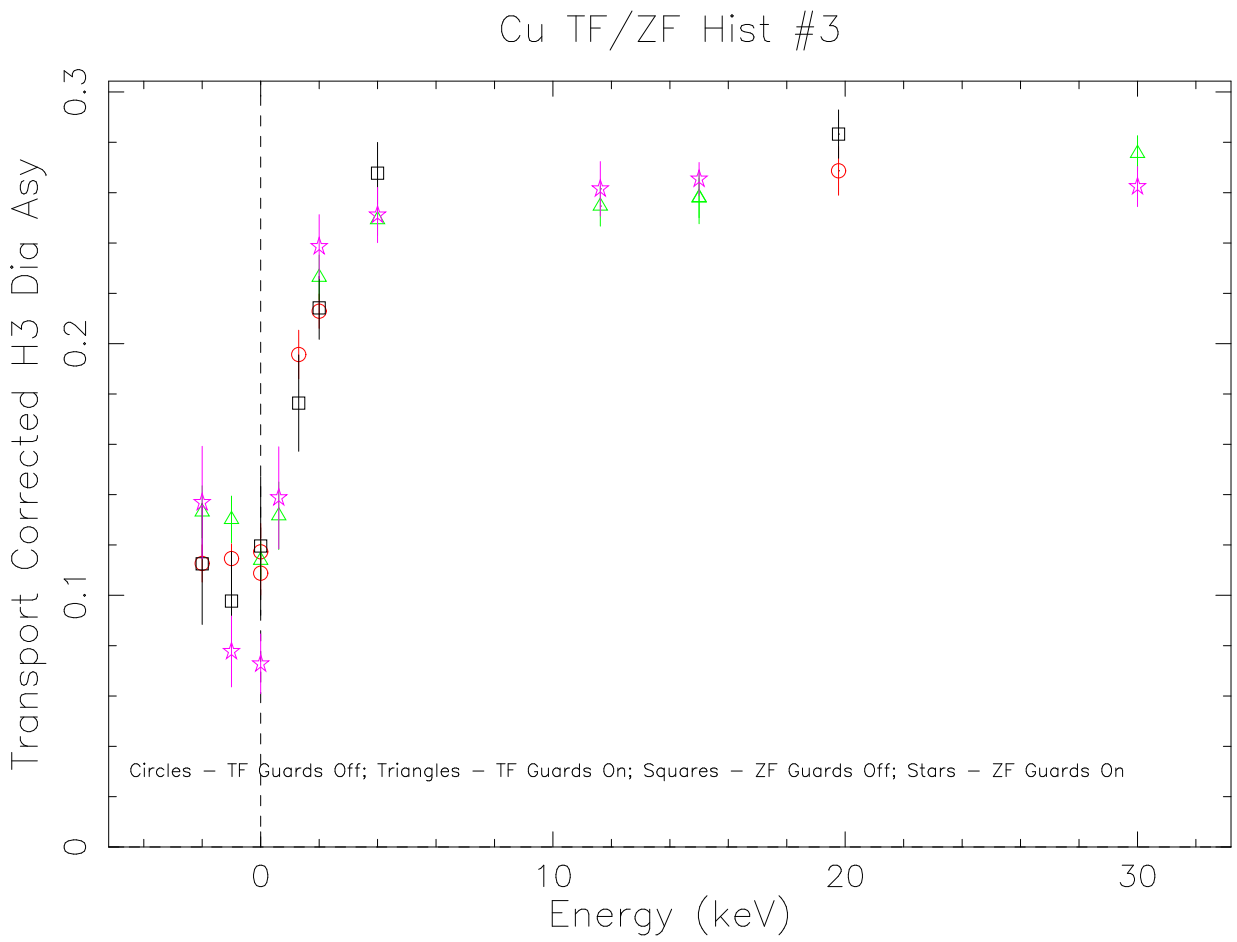
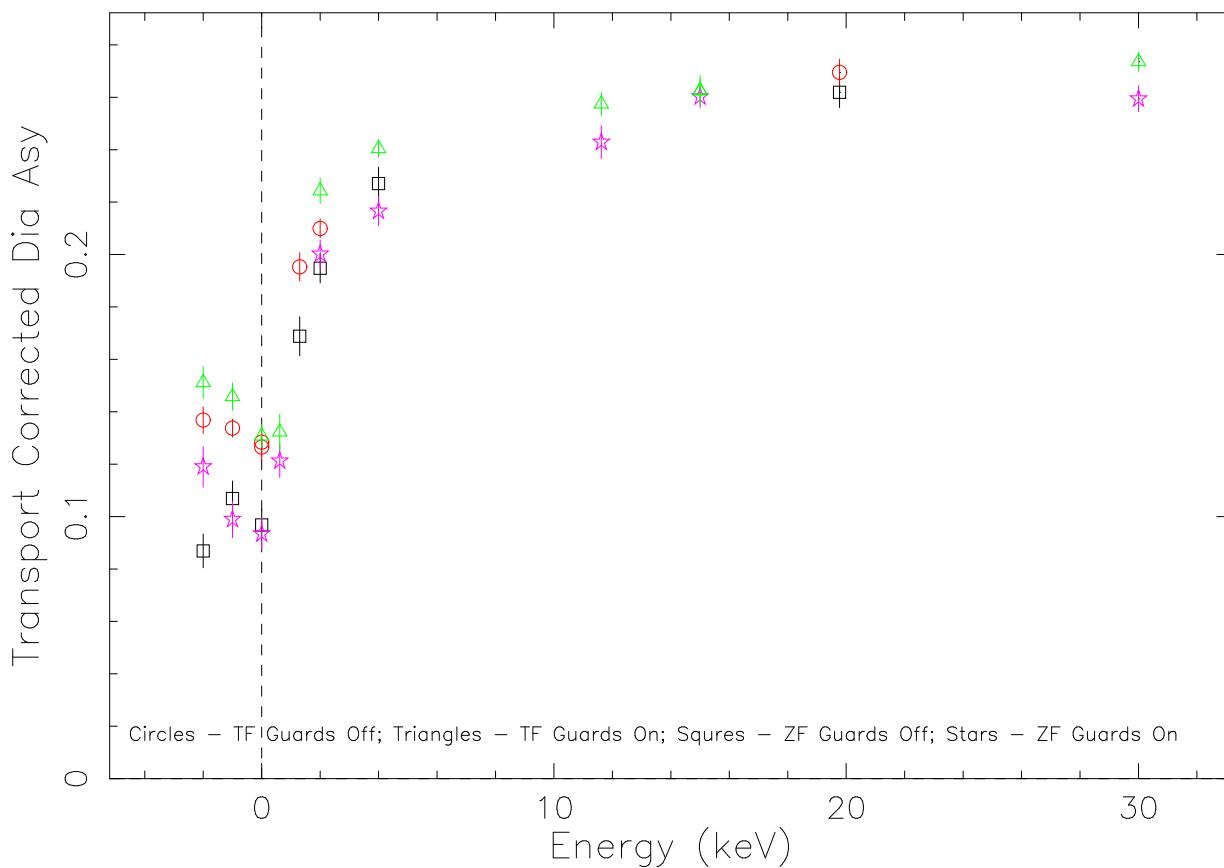


Figure 7: Cu TF=50G and ZF H3 fits. One can see no difference between TF and ZF data.

### Cu TF/ZF Asymmetry Fits



### Cu ZF/TF T=20K Asymmetry Fits

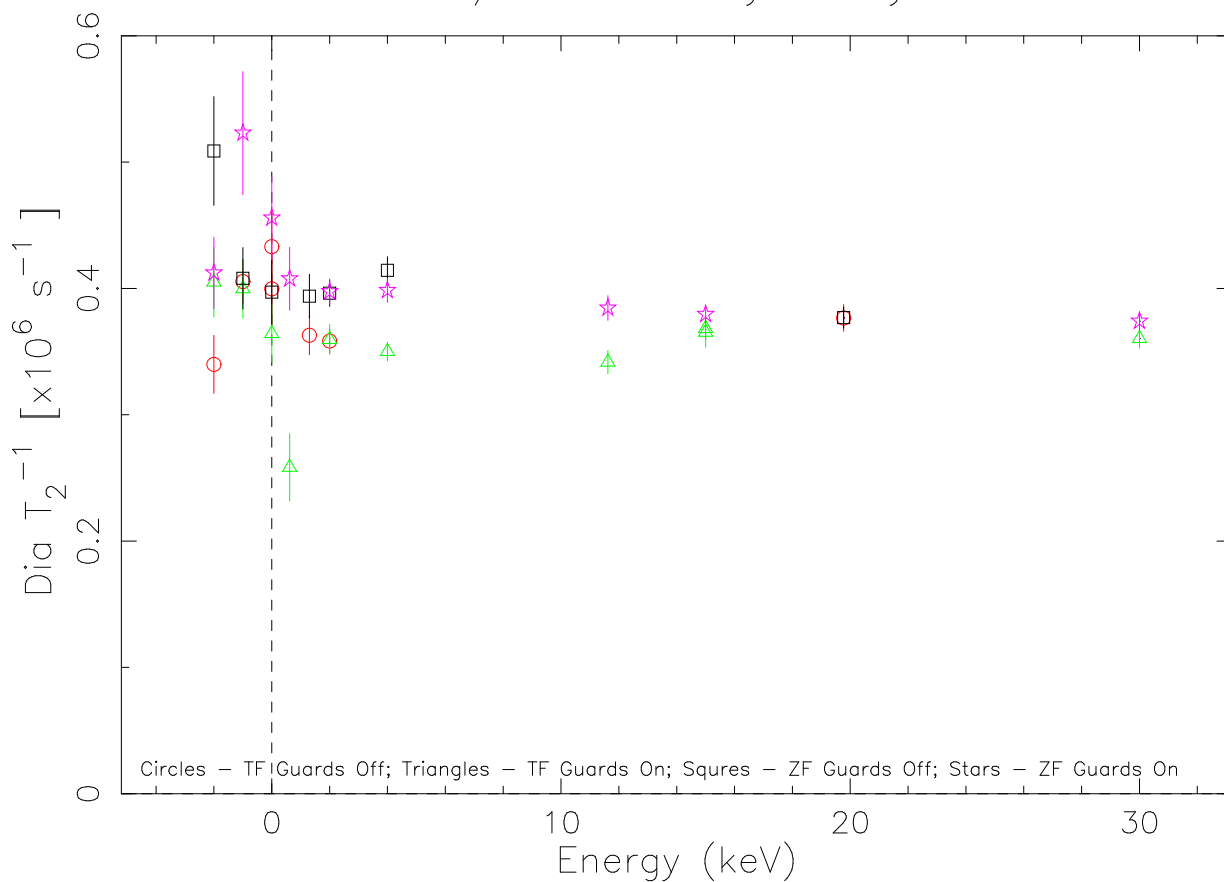
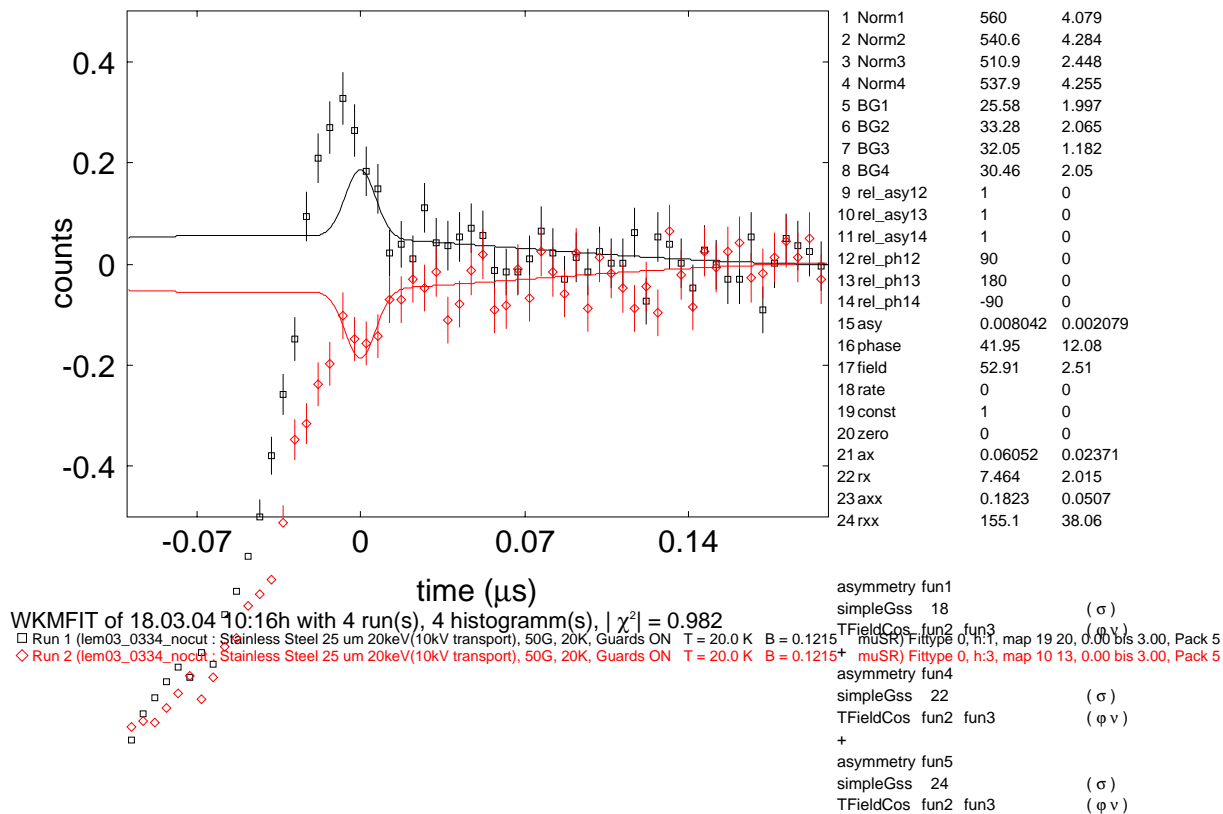


Figure 8: Cu TF=50G and ZF 1324 asymmetry fits. One can see that TF and ZF data are very close.

# lem03\_0334\_nocut: Stainless Steel 25 um 20keV(10kV transpor



# lem03\_0334\_nocut: Stainless Steel 25 um 20keV(10kV transpor

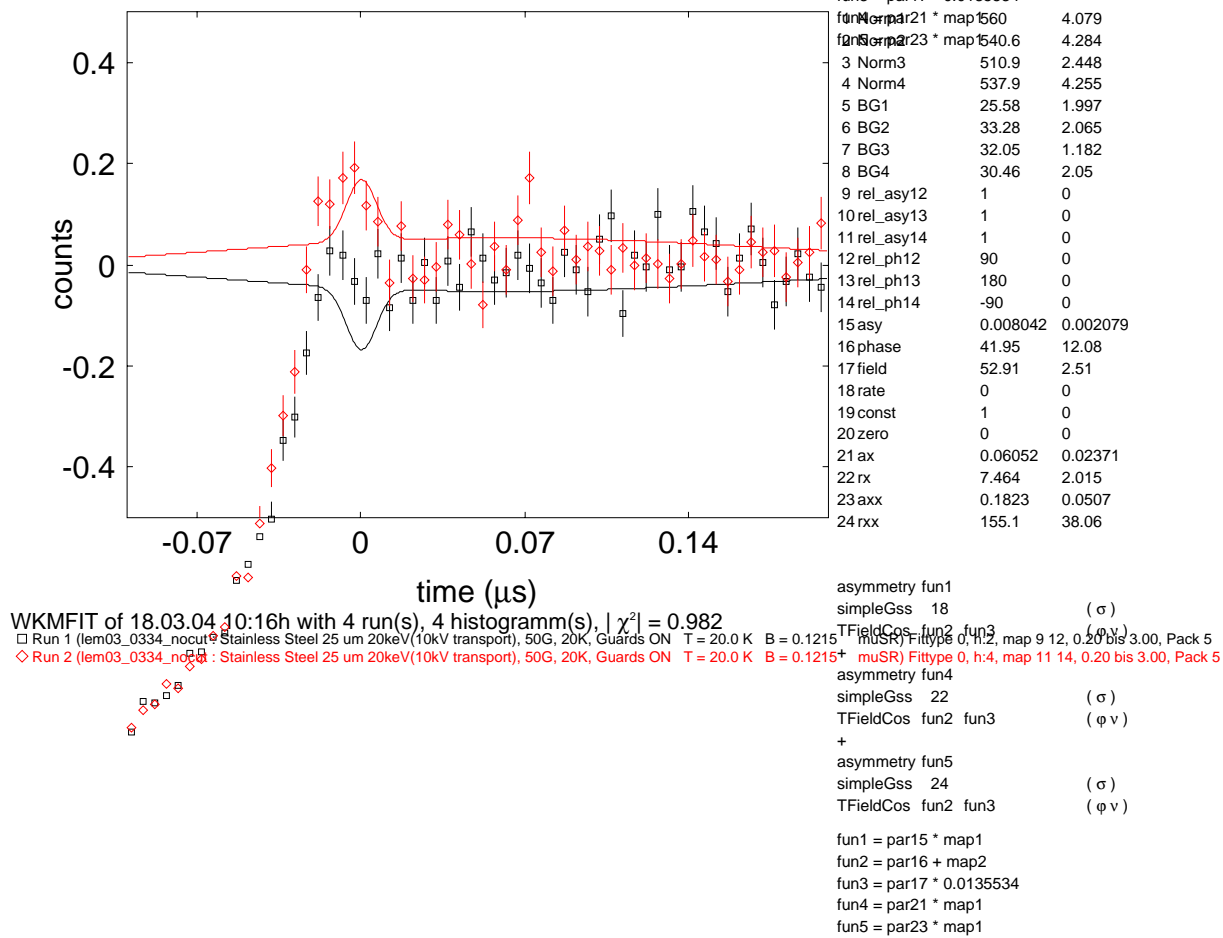
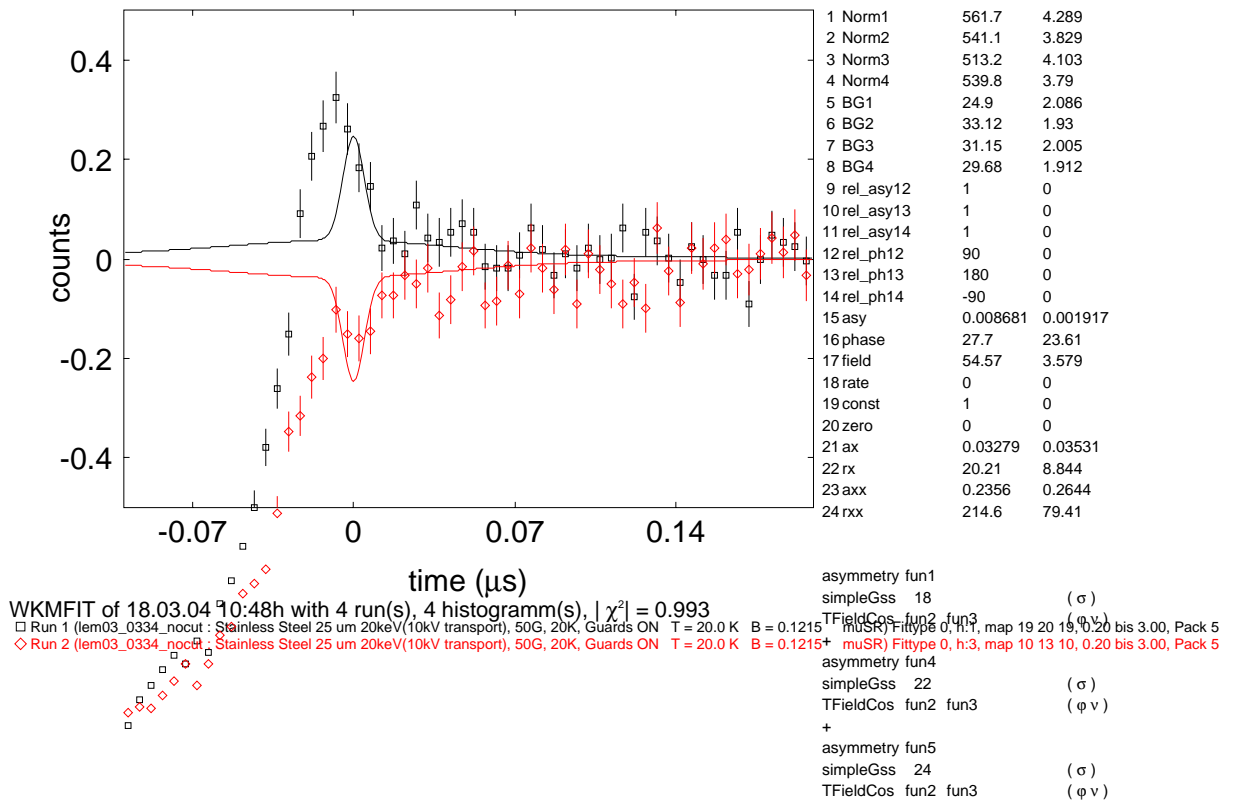


Figure 9: Up: histograms #1 and #3 are fitted with common fast relaxation. Down: this fast signal is plotted (not fitted) for histograms #2 and #4. One can see mismatch between the plotted theory and data for the histogram #2.

lem03\_0334\_nocut: Stainless Steel 25 um 20keV(10kV transpor



lem03\_0334\_nocut: Stainless Steel 25 um 20keV(10kV transpor

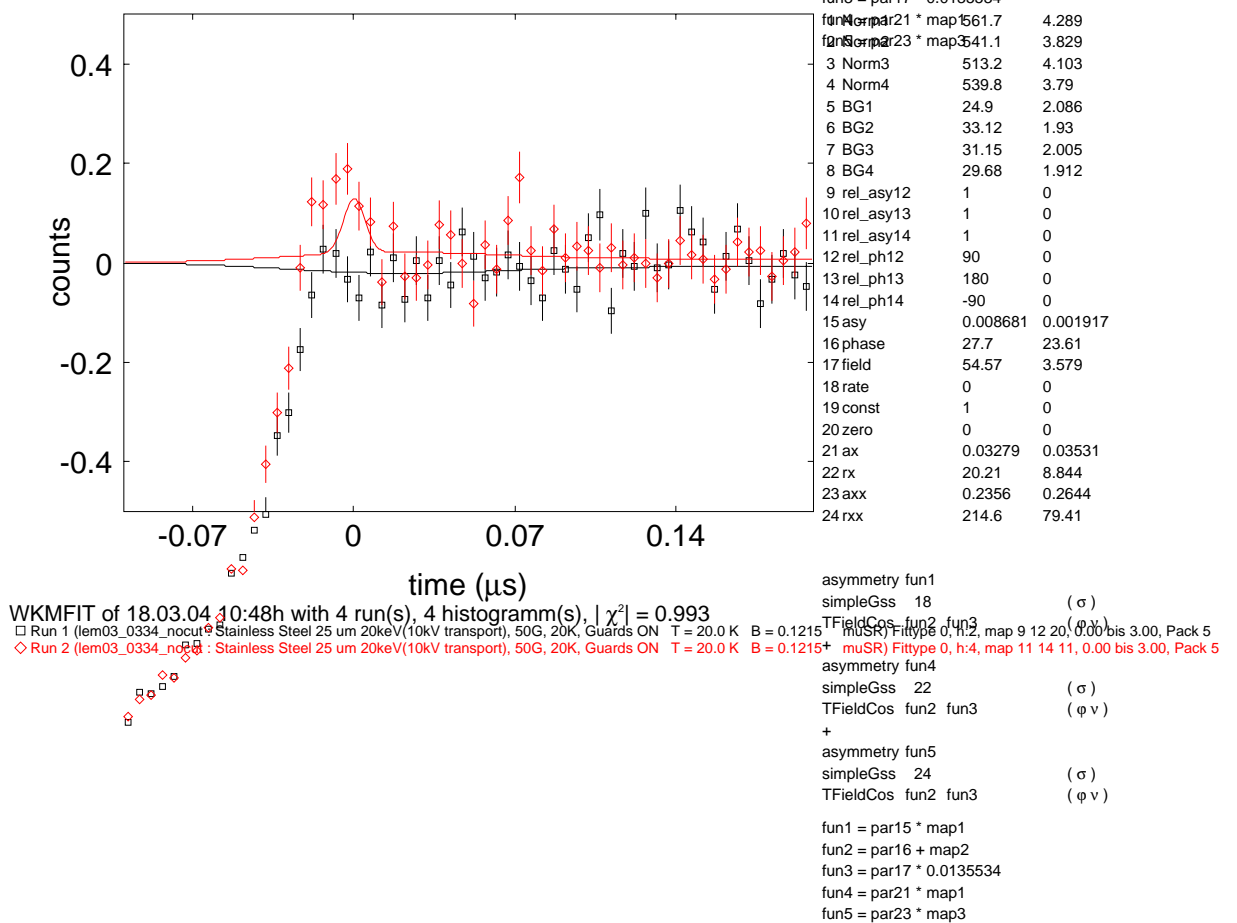
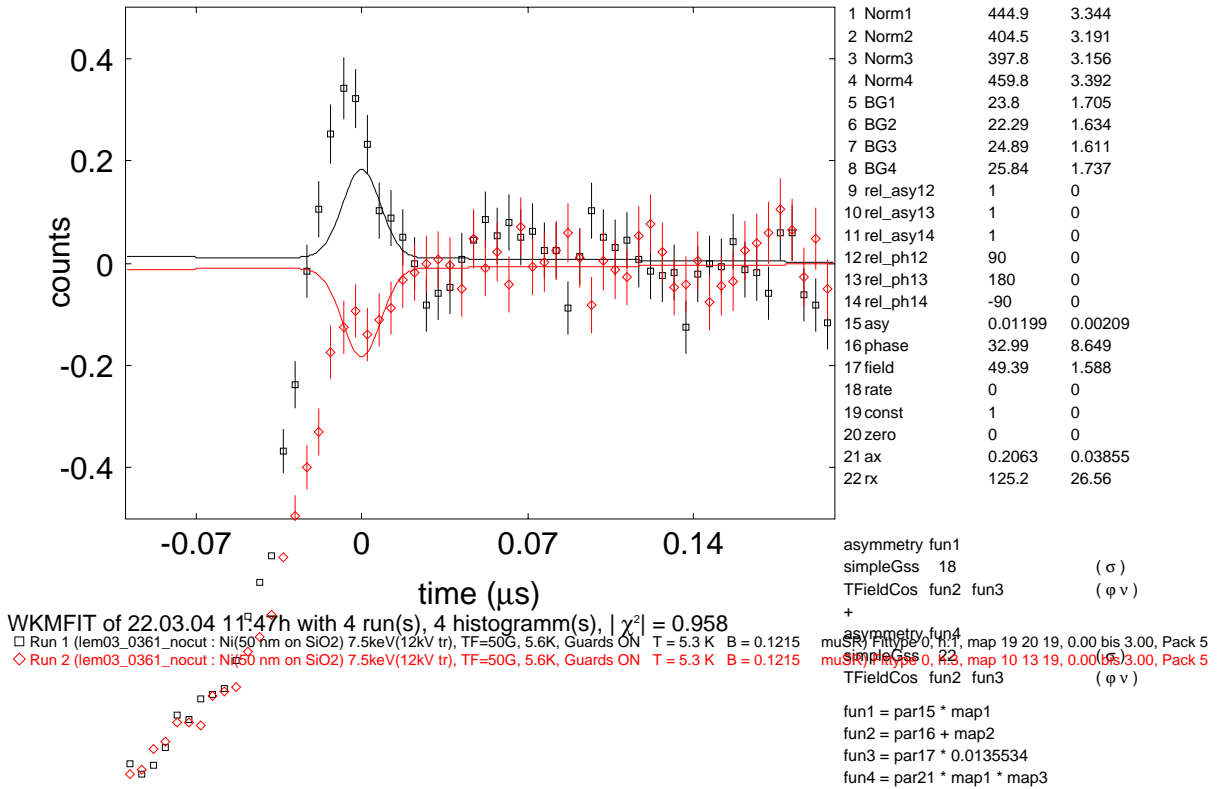


Figure 10: Down: histograms #4 is fitted with fast relaxation while the signal in histogram #2 is forced to be slow relaxing; Up: fast relaxing signal from histogram #4 is plotted for histograms #1 and #3 in a good agreement with experimental data.

lem03\_0361\_nocut: Ni(50 nm on SiO2) 7.5keV(12kV tr), TF=50G



lem03\_0361\_nocut: Ni(50 nm on SiO2) 7.5keV(12kV tr), TF=50G

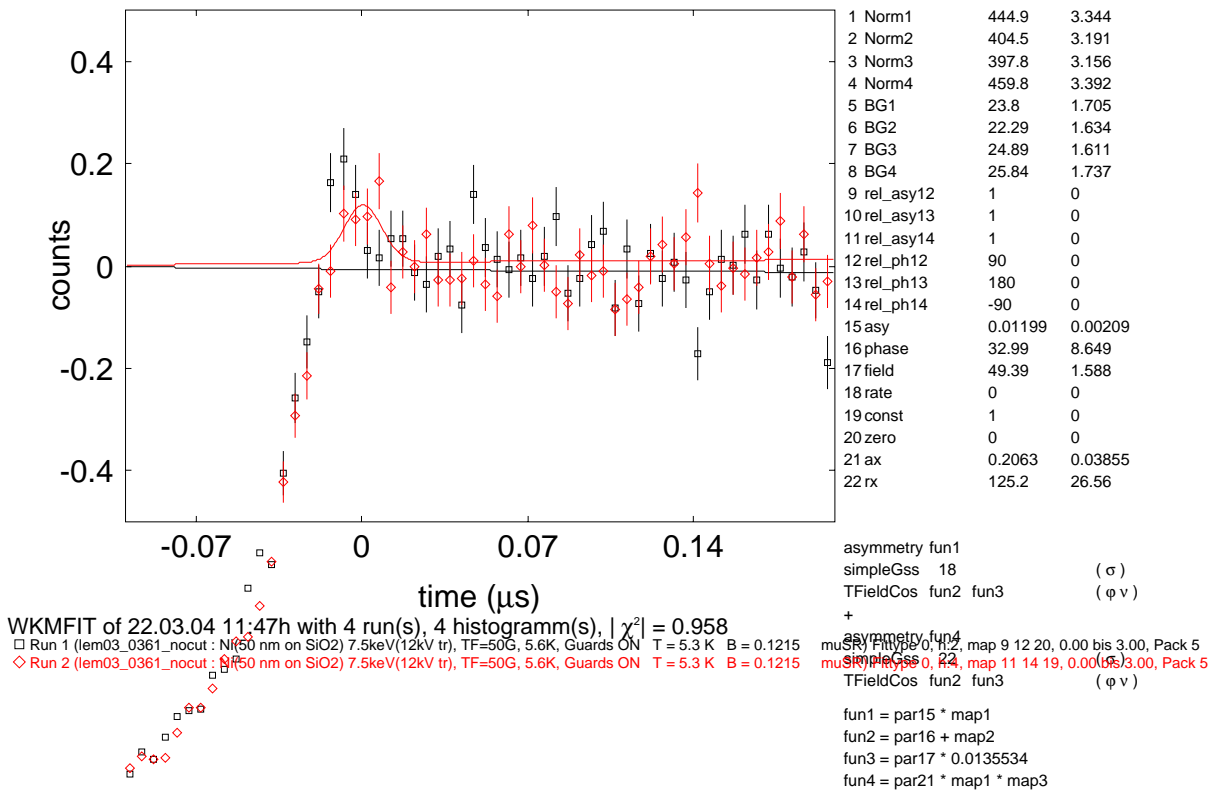


Figure 11: Ni at 5.6 K. Down: histograms #4 is fitted with fast relaxation while the signal in histogram #2 is forced to be slow relaxing; Up: fast relaxing signal from histogram #4 is plotted for histograms #1 and #3 in a good agreement with experimental data.

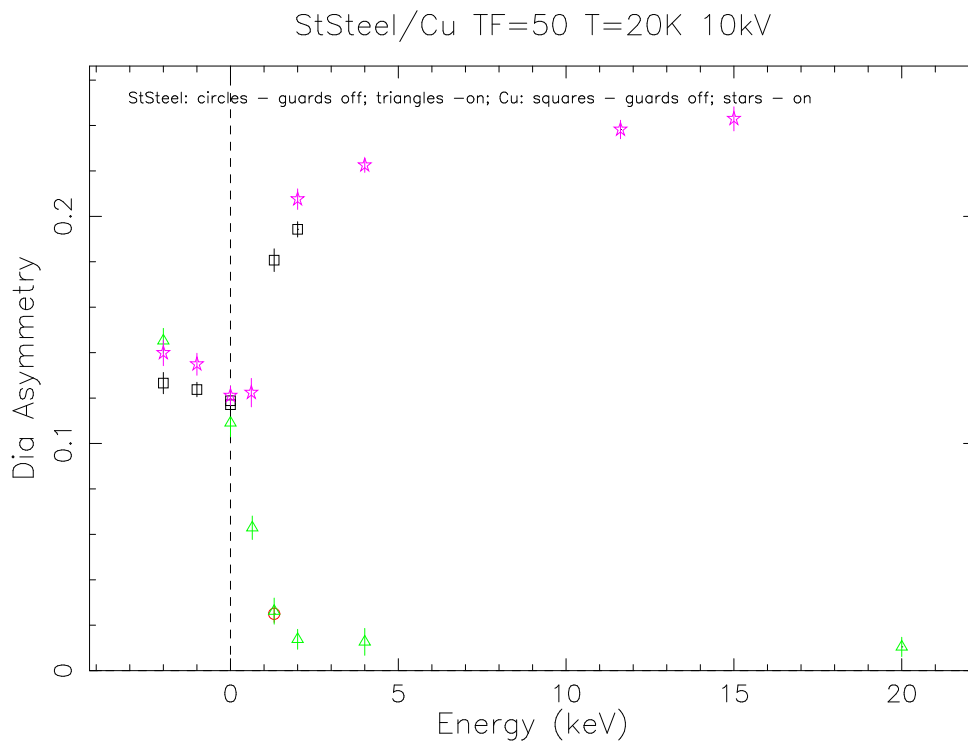


Figure 12: Energy dependences of the slow relaxing diamagnetic asymmetry in Stainless Steel and Cu measured at  $T=20\text{K}$  in  $TF=50\text{G}$ .

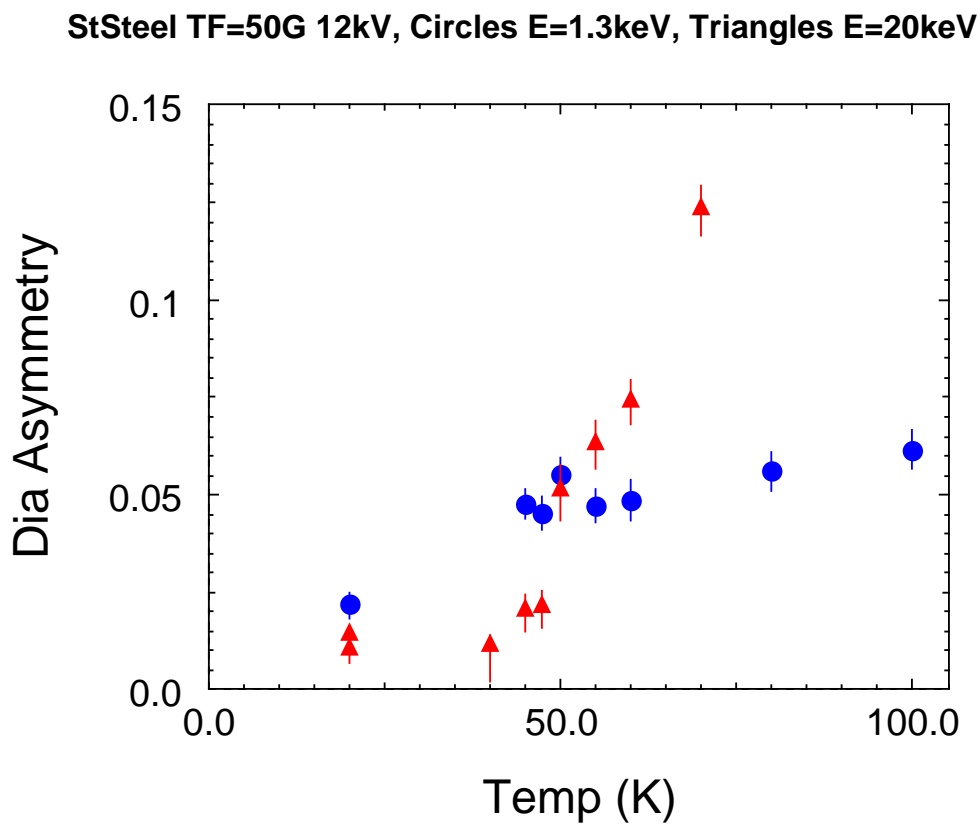


Figure 13: Temperature dependences of the slow relaxing diamagnetic asymmetry in the Stainless Steel foil.

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278 600.6k 11.62keV Cu 50G rings on
279 605.9k 11.62keV H=0G rings on
280 634.6k Cu 500nm 0.62keV H=0G 20K, sample rings are on
283 239.4k Cu 500nm 0.62keV(10kV transport) H=50G 20K, sample rings are on
298 503.9k Cu 500nm 19.77keV(20kV transport) H=50G 20K, Guards off
299 536.4k Cu 500nm 19.77keV(20kV transport), ZF, 20K Guards off
300 752.9k Cu 500nm 30keV(20kV transport), ZF, 20K, beamline tests Guards on
301 701.5k Cu 500nm 30keV(20kV transport), 50G, 20K, Ne14_2 now Guards On
303 502.7k Cu 500nm 15keV(20kV transport), 50G, 20K, Ne14_2, continue Gua On
304 1041.8k Cu 500nm 15keV(20kV transport), ZF, 20K, Guards on
306 117.4k Cu 500nm 15keV(10kV transport), 50G, 20K, Guards on
307 408.5k Cu 500nm 15keV(10kV transport), 50G, 20K, Guards on
308 1135.1k Cu 500nm 4keV(10kV transport), 50G, 20K, Guards on
309 787.3k Cu 500nm 4keV(10kV transport), 0G, 20K, Guards on
310 639.3k Cu 500nm 4keV(10kV transport), 0G, 20K, Guards off
311 576.8k Cu 500nm 2keV(10kV transport), 50G, 20K, Guards on
312 897.4k Cu 500nm 2keV(10kV transport), 0G, 20K, Guards on
313 826.1k Cu 500nm 2keV(10kV transport), 0G, 20K, Guards off
314 1048.5k Cu 500nm 2keV(10kV transport), TF=50G, 20K, Guards off
315 826.6k Cu 500nm 0keV(10kV transport), TF=50G, 20K, Guards on
316 798.9k Cu 500nm 0keV(10kV transport), ZF, 20K, Guards on
317 737.5k Cu 500nm 0keV(10kV transport), ZF, 20K, Guards off
318 598.9k Cu 500nm 0keV(10kV transport), TF=50G, 20K, Guards off
319 1405.7k Cu 500nm -1keV(10kV transport), TF=50G, 20K, Guards off
320 600.8k Cu 500nm -1keV(10kV transport), TF=50G, 20K, Guards ON
321 612.8k Cu 500nm -1keV(10kV transport), ZF, 20K, Guards ON
322 606.8k Cu 500nm -1keV(10kV transport), ZF, 20K, Guards OFF
323 667.2k Cu 500nm -2keV(10kV transport), ZF, 20K, Guards OFF
324 604.1k Cu 500nm -2keV(10kV transport), 50G, 20K, Guards OFF
325 501.4k Cu 500nm -2keV(10kV transport), 50G, 20K, Guards ON
326 501.5k Cu 500nm -2keV(10kV transport), ZF, 20K, Guards ON
327 500.9k Cu 500nm 1.3keV(10kV transport), 50G, 20K, Guards OFF
328 503.1k Cu 500nm 1.3keV(10kV transport), ZF, 20K, Guards OFF
329 512.4k Cu 500nm 0keV(10kV transport), -50G, 20K, Guards OFF

334 1263.2k Stainless Steel 25 um 20keV(10kV transport), 50G, 20K, Guards ON
335 992.9k StSteel 25um 4keV(10kV tr), 50G, 20K, Guards ON
336 934.7k StSteel 25um 1.3keV(10kV tr), 50G, 20K, Guards ON
337 1242.4k StSteel 25um 1.3keV(10kV tr), 50G, 20K, Guards OFF
338 1210.6k StSteel 25um 1.3keV(10kV tr), ZF, 20K, Guards ON
339 925.4k StSteel 25um 20keV(10kV tr), ZF, 20K, Guards ON
340 1122.0k StSteel 25um -2keV(10kV tr), TF=50G, 20K, Guards ON
341 769.3k StSteel 25um -2keV(10kV tr), ZF, 20K, Guards ON
342 663.6k StSteel 25um 0keV(10kV tr), TF=50G, 20K, Guards ON
343 915.5k StSteel 25um 0.65keV(10kV tr), TF=50G, 20K, Guards ON
344 1012.2k StSteel 25um 2keV(10kV tr), TF=50G, 20K, Guards ON
346 604.4k StSteel 25um 20keV(12kV tr), TF=50G, 40K, Guards ON
347 643.2k StSteel 25um 20keV(12kV tr), TF=50G, 60K, Guards ON
348 615.4k StSteel 25um 20keV(12kV tr), TF=50G, 70K, Guards ON
349 607.4k StSteel 25um 20keV(12kV tr), TF=50G, 50K, Guards ON
350 692.7k StSteel 25um 20keV(12kV tr), TF=50G, 45K, Guards ON
351 602.3k StSteel 25um 20keV(12kV tr), TF=50G, 47.5K, Guards ON
352 602.7k StSteel 25um 20keV(12kV tr), TF=50G, 55K, Guards ON
353 602.0k StSteel 25um 1.3keV(12kV tr), TF=50G, 55K, Guards ON
354 602.5k StSteel 25um 1.3keV(12kV tr), TF=50G, 50K, Guards ON
355 623.2k StSteel 25um 1.3keV(12kV tr), TF=50G, 47.5K, Guards ON
356 781.5k StSteel 25um 1.3keV(12kV tr), TF=50G, 45K, Guards ON
357 417.6k StSteel 25um 1.3keV(12kV tr), TF=50G, 60K, Guards ON
358 461.3k StSteel 25um 1.3keV(12kV tr), TF=50G, 80K, Guards ON
359 456.1k StSteel 25um 1.3keV(12kV tr), TF=50G, 100K, Guards ON

360 2384.1k Ni(50 nm on SiO2) 7.5keV(12kV tr), ZF, 5.6K, Guards ON
361 1011.1k Ni(50 nm on SiO2) 7.5keV(12kV tr), TF=50G, 5.6K, Guards ON
362 1010.6k Ni(50 nm on SiO2) 3.5keV(12kV tr), TF=50G, 5.3K, Guards ON
363 1133.3k Ni(50 nm on SiO2) 10keV(12kV tr), TF=50G, 5.2K, Guards ON

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Figure 14: List of runs under consideration. See \*.DB and \*.ps files in nemu@pc3159: /analysis/WKM/2003/Cu or nemu@pc3159: /analysis/WKM/2003/StSteel nemu@pc3159: /analysis/WKM/2003/Ni directories.